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### Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

### Applications of Embedded - CPLDs

#### Details

Product Status	Obsolete
Programmable Type	In-System Reprogrammable™ (ISR™) CMOS
Delay Time tpd(1) Max	12 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	-
Number of Macrocells	256
Number of Gates	-
Number of I/O	133
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	160-LQFP
Supplier Device Package	160-TQFP (24x24)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/infineon-technologies/cy37256vp160-100axc">https://www.e-xfl.com/product-detail/infineon-technologies/cy37256vp160-100axc</a>

The buried macrocell also supports input register capability. The buried macrocell can be configured to act as an input register (D-type or latch) whose input comes from the I/O pin associated with the neighboring macrocell. The output of all buried macrocells is sent directly to the PIM regardless of its configuration.

### I/O Macrocell

Figure 2 illustrates the architecture of the I/O macrocell. The I/O macrocell supports the same functions as the buried macrocell with the addition of I/O capability. At the output of the macrocell, a polarity control mux is available to select active LOW or active HIGH signals. This has the added advantage of allowing significant logic reduction to occur in many applications.

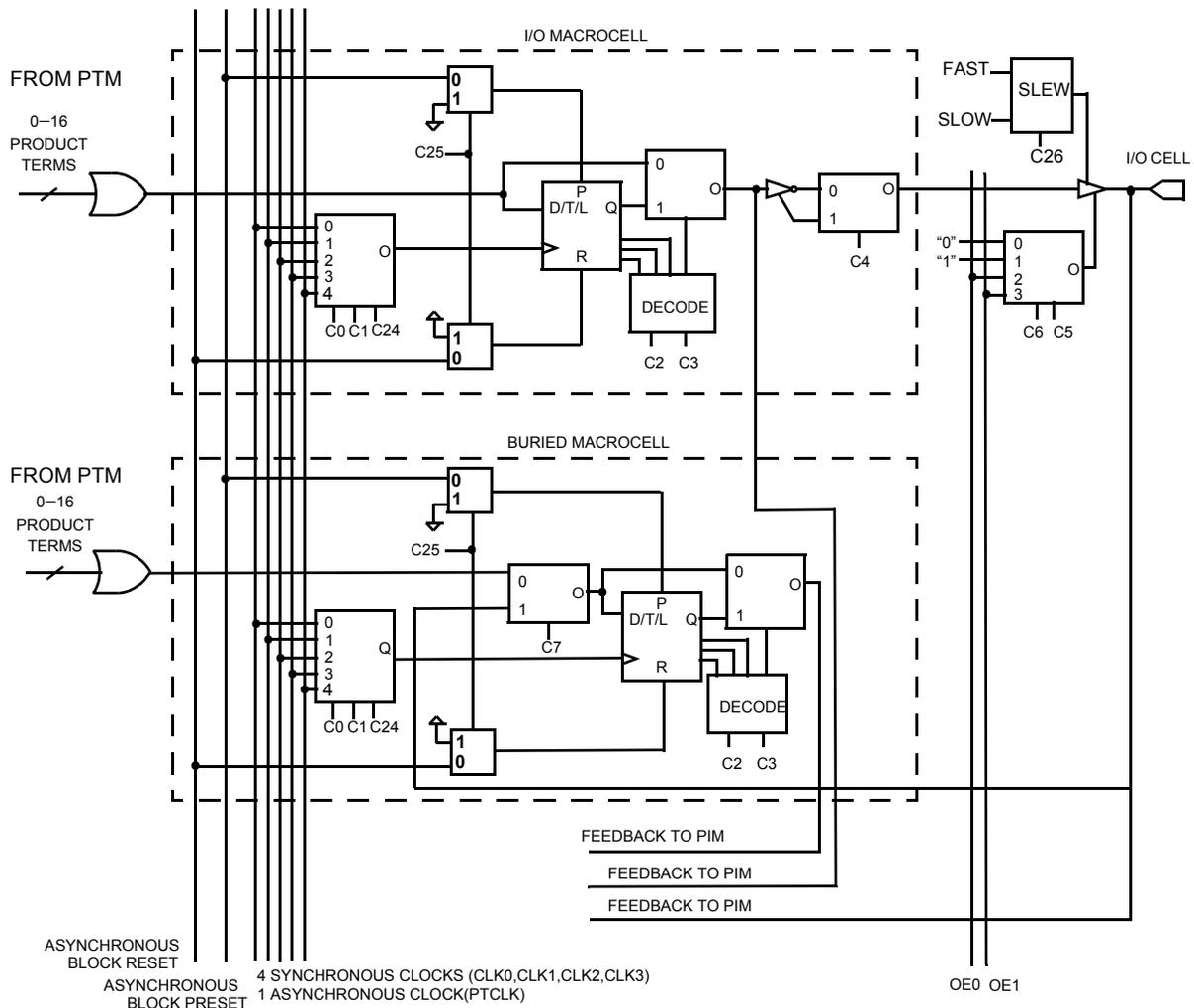
The Ultra37000 macrocell features a feedback path to the PIM separate from the I/O pin input path. This means that if the macrocell is buried (fed back internally only), the associated I/O pin can still be used as an input.

### Bus Hold Capabilities on all I/Os

Bus-hold, which is an improved version of the popular internal pull-up resistor, is a weak latch connected to the pin that does not degrade the device's performance. As a latch, bus-hold maintains the last state of a pin when the pin is placed in a high-impedance state, thus reducing system noise in bus-interface applications. Bus-hold additionally allows unused device pins to remain unconnected on the board, which is particularly useful during prototyping as designers can route new signals to the device without cutting trace connections to V<sub>CC</sub> or GND. For more information, see the application note *Understanding Bus-Hold—A Feature of Cypress CPLDs*.

### Programmable Slew Rate Control

Each output has a programmable configuration bit, which sets the output slew rate to fast or slow. For designs concerned with meeting FCC emissions standards the slow edge provides for lower system noise. For designs requiring very high performance the fast edge rate provides maximum system performance.



**Figure 2. I/O and Buried Macrocells**

**Inductance<sup>[5]</sup>**

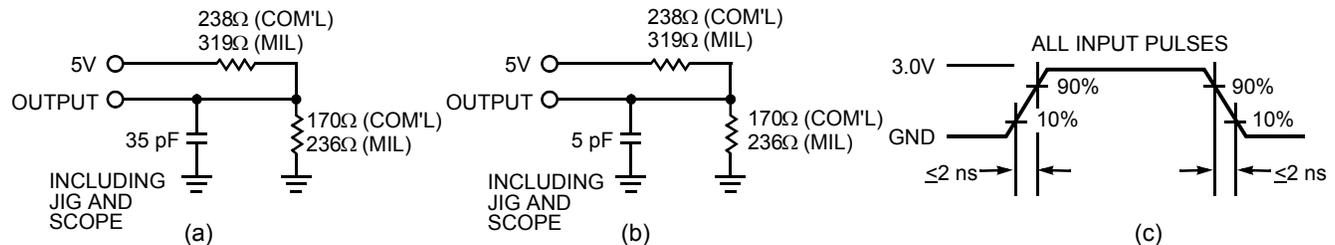
Parameter	Description	Test Conditions	44-Lead TQFP	44-Lead PLCC	44-Lead CLCC	84-Lead PLCC	84-Lead CLCC	100-Lead TQFP	160-Lead TQFP	208-Lead PQFP	Unit
L	Maximum Pin Inductance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$	2	5	2	8	5	8	9	11	nH

**Capacitance<sup>[5]</sup>**

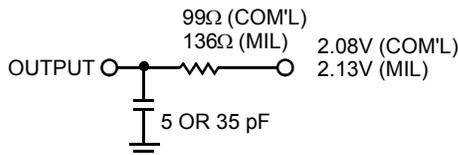
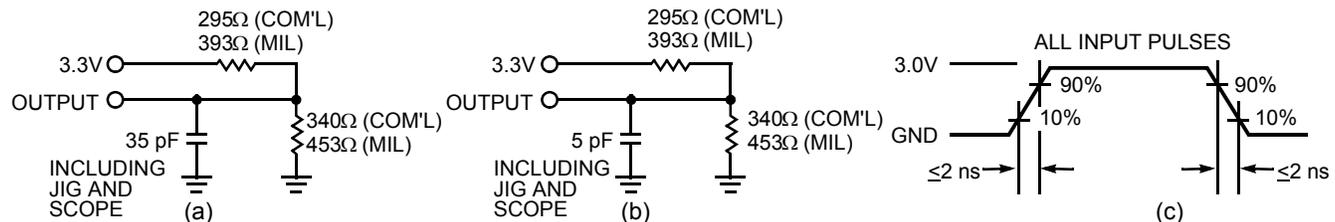
Parameter	Description	Test Conditions	Max.	Unit
$C_{I/O}$	Input/Output Capacitance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	8	pF
$C_{CLK}$	Clock Signal Capacitance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	12	pF
$C_{DP}$	Dual Functional Pins <sup>[9]</sup>	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	16	pF

**Endurance Characteristics<sup>[5]</sup>**

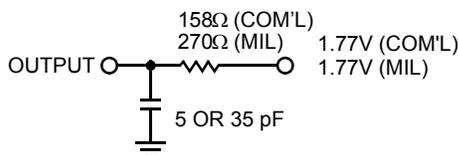
Parameter	Description	Test Conditions	Min.	Typ.	Unit
N	Minimum Reprogramming Cycles	Normal Programming Conditions <sup>[2]</sup>	1,000	10,000	Cycles

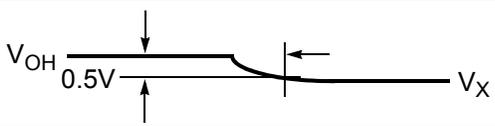
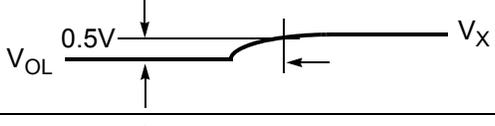
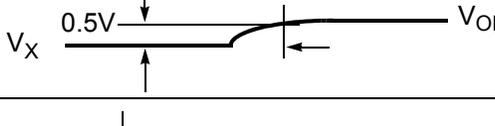
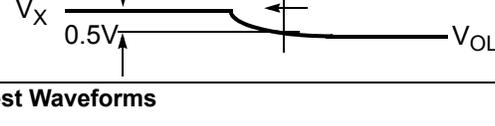
**AC Characteristics**
**5.0V AC Test Loads and Waveforms**


Equivalent to: THÉVENIN EQUIVALENT


**3.3V AC Test Loads and Waveforms**


Equivalent to: THÉVENIN EQUIVALENT



Parameter <sup>[11]</sup>	V <sub>X</sub>	Output Waveform—Measurement Level
t <sub>ER(-)</sub>	1.5V	
t <sub>ER(+)</sub>	2.6V	
t <sub>EA(+)</sub>	1.5V	
t <sub>EA(-)</sub>	V <sub>the</sub>	

**(d) Test Waveforms**
**Switching Characteristics** Over the Operating Range <sup>[12]</sup>

Parameter	Description	Unit
<b>Combinatorial Mode Parameters</b>		
t <sub>PD</sub> <sup>[13, 14, 15]</sup>	Input to Combinatorial Output	ns
t <sub>PDL</sub> <sup>[13, 14, 15]</sup>	Input to Output Through Transparent Input or Output Latch	ns
t <sub>PDLL</sub> <sup>[13, 14, 15]</sup>	Input to Output Through Transparent Input and Output Latches	ns
t <sub>EA</sub> <sup>[13, 14, 15]</sup>	Input to Output Enable	ns
t <sub>ER</sub> <sup>[11, 13]</sup>	Input to Output Disable	ns
<b>Input Register Parameters</b>		
t <sub>WL</sub>	Clock or Latch Enable Input LOW Time <sup>[8]</sup>	ns
t <sub>WH</sub>	Clock or Latch Enable Input HIGH Time <sup>[8]</sup>	ns
t <sub>IS</sub>	Input Register or Latch Set-up Time	ns
t <sub>IH</sub>	Input Register or Latch Hold Time	ns
t <sub>CO</sub> <sup>[13, 14, 15]</sup>	Input Register Clock or Latch Enable to Combinatorial Output	ns
t <sub>COL</sub> <sup>[13, 14, 15]</sup>	Input Register Clock or Latch Enable to Output Through Transparent Output Latch	ns
<b>Synchronous Clocking Parameters</b>		
t <sub>CO</sub> <sup>[14, 15]</sup>	Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable to Output	ns
t <sub>S</sub> <sup>[13]</sup>	Set-Up Time from Input to Sync. Clk (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable	ns
t <sub>H</sub>	Register or Latch Data Hold Time	ns
t <sub>CO2</sub> <sup>[13, 14, 15]</sup>	Output Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable to Combinatorial Output Delay (Through Logic Array)	ns
t <sub>SCS</sub> <sup>[13]</sup>	Output Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable to Output Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable (Through Logic Array)	ns
t <sub>SL</sub> <sup>[13]</sup>	Set-Up Time from Input Through Transparent Latch to Output Register Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable	ns
t <sub>HL</sub>	Hold Time for Input Through Transparent Latch from Output Register Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable	ns

**Notes:**

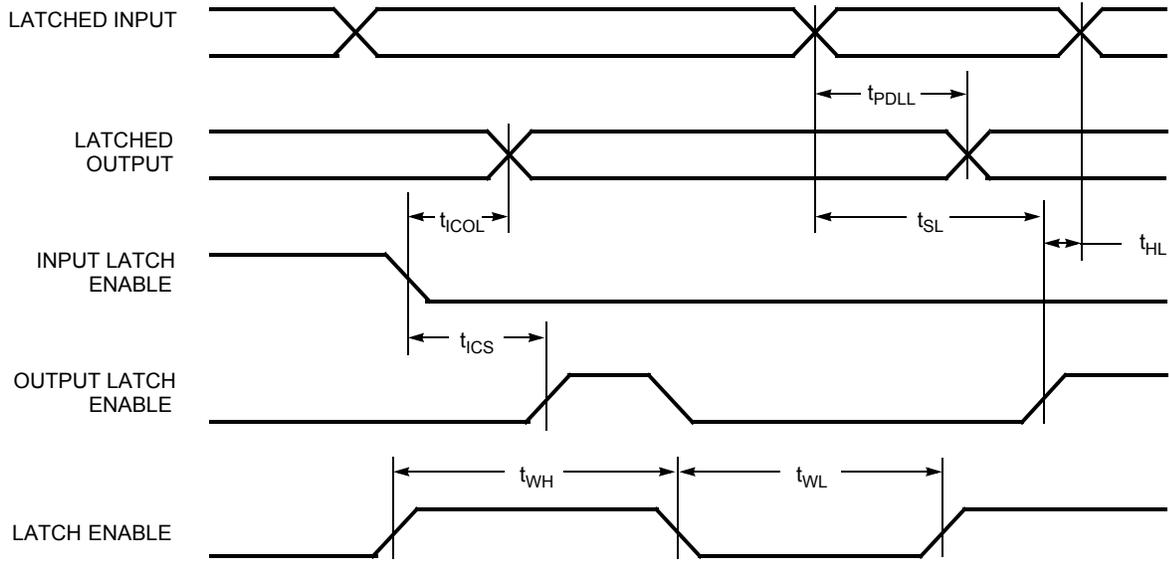
11. t<sub>ER</sub> measured with 5-pF AC Test Load and t<sub>EA</sub> measured with 35-pF AC Test Load.
12. All AC parameters are measured with two outputs switching and 35-pF AC Test Load.
13. Logic Blocks operating in Low-Power Mode, add t<sub>LP</sub> to this spec.
14. Outputs using Slow Output Slew Rate, add t<sub>SLEW</sub> to this spec.
15. When V<sub>CC0</sub> = 3.3V, add t<sub>3,310</sub> to this spec.

**Switching Characteristics** Over the Operating Range (continued)<sup>[12]</sup>

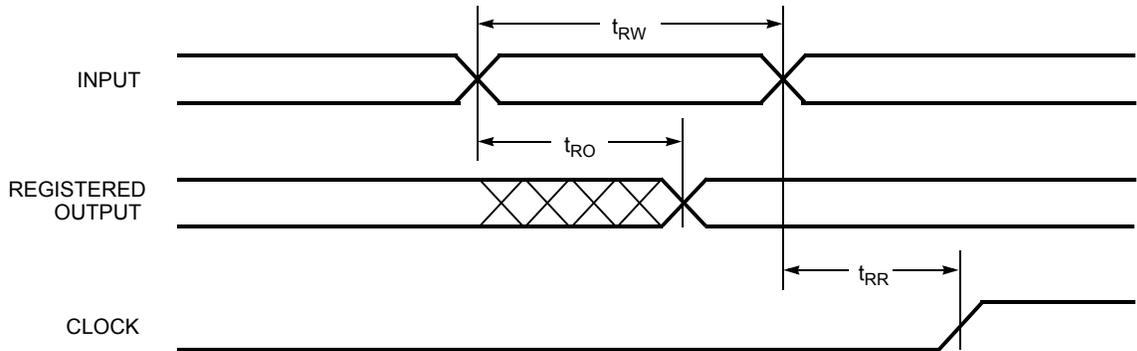
Parameter	Description	Unit
<b>Product Term Clocking Parameters</b>		
$t_{COPT}^{[13, 14, 15]}$	Product Term Clock or Latch Enable (PTCLK) to Output	ns
$t_{SPT}$	Set-Up Time from Input to Product Term Clock or Latch Enable (PTCLK)	ns
$t_{HPT}$	Register or Latch Data Hold Time	ns
$t_{ISPT}^{[13]}$	Set-Up Time for Buried Register used as an Input Register from Input to Product Term Clock or Latch Enable (PTCLK)	ns
$t_{IHPT}$	Buried Register Used as an Input Register or Latch Data Hold Time	ns
$t_{CO2PT}^{[13, 14, 15]}$	Product Term Clock or Latch Enable (PTCLK) to Output Delay (Through Logic Array)	ns
<b>Pipelined Mode Parameters</b>		
$t_{ICS}^{[13]}$	Input Register Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) to Output Register Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> )	ns
<b>Operating Frequency Parameters</b>		
$f_{MAX1}$	Maximum Frequency with Internal Feedback (Lesser of $1/t_{SCS}$ , $1/(t_S + t_H)$ , or $1/t_{CO}$ ) <sup>[5]</sup>	MHz
$f_{MAX2}$	Maximum Frequency Data Path in Output Registered/Latched Mode (Lesser of $1/(t_{WL} + t_{WH})$ , $1/(t_S + t_H)$ , or $1/t_{CO}$ ) <sup>[5]</sup>	MHz
$f_{MAX3}$	Maximum Frequency with External Feedback (Lesser of $1/(t_{CO} + t_S)$ or $1/(t_{WL} + t_{WH})$ ) <sup>[5]</sup>	MHz
$f_{MAX4}$	Maximum Frequency in Pipelined Mode (Lesser of $1/(t_{CO} + t_S)$ , $1/t_{ICS}$ , $1/(t_{WL} + t_{WH})$ , $1/(t_{IS} + t_{IH})$ , or $1/t_{SCS}$ ) <sup>[5]</sup>	MHz
<b>Reset/Preset Parameters</b>		
$t_{RW}$	Asynchronous Reset Width <sup>[5]</sup>	ns
$t_{RR}^{[13]}$	Asynchronous Reset Recovery Time <sup>[5]</sup>	ns
$t_{RO}^{[13, 14, 15]}$	Asynchronous Reset to Output	ns
$t_{PW}$	Asynchronous Preset Width <sup>[5]</sup>	ns
$t_{PR}^{[13]}$	Asynchronous Preset Recovery Time <sup>[5]</sup>	ns
$t_{PO}^{[13, 14, 15]}$	Asynchronous Preset to Output	ns
<b>User Option Parameters</b>		
$t_{LP}$	Low Power Adder	ns
$t_{SLEW}$	Slow Output Slew Rate Adder	ns
$t_{3.3IO}$	3.3V I/O Mode Timing Adder <sup>[5]</sup>	ns
<b>JTAG Timing Parameters</b>		
$t_{S JTAG}$	Set-up Time from TDI and TMS to TCK <sup>[5]</sup>	ns
$t_{H JTAG}$	Hold Time on TDI and TMS <sup>[5]</sup>	ns
$t_{CO JTAG}$	Falling Edge of TCK to TDO <sup>[5]</sup>	ns
$f_{JTAG}$	Maximum JTAG Tap Controller Frequency <sup>[5]</sup>	ns

**Switching Waveforms (continued)**

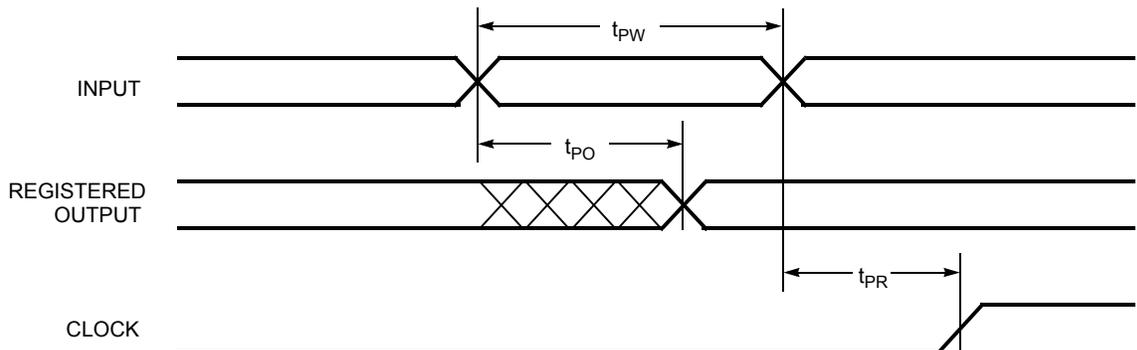
**Latched Input and Output**



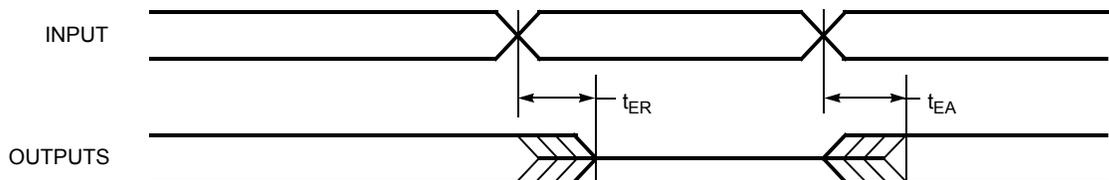
**Asynchronous Reset**



**Asynchronous Preset**

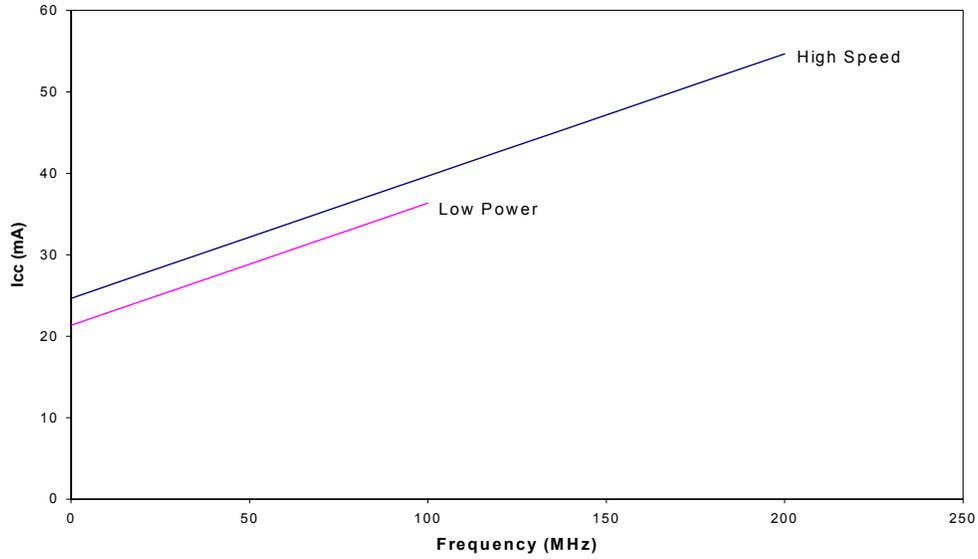


**Output Enable/Disable**



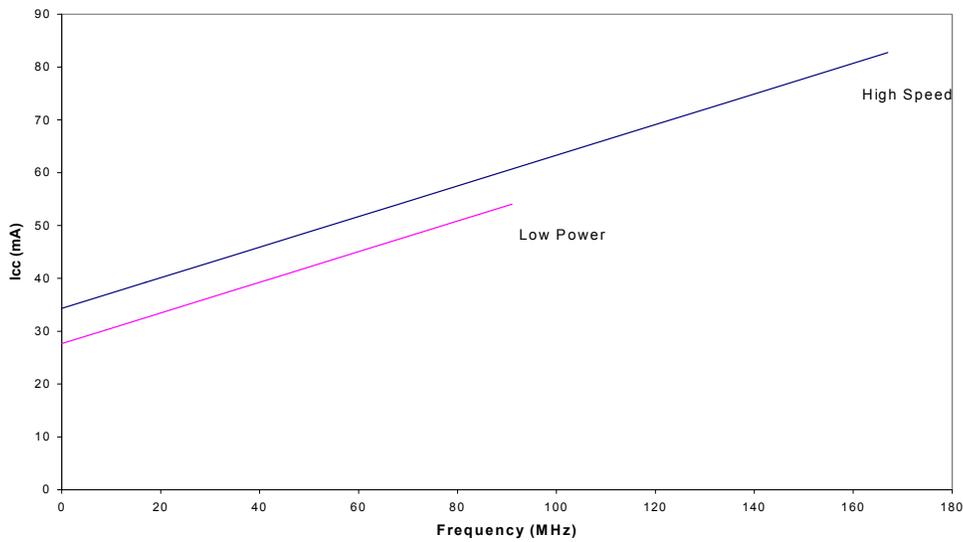
**Power Consumption**

**Typical 5.0V Power Consumption  
CY37032**



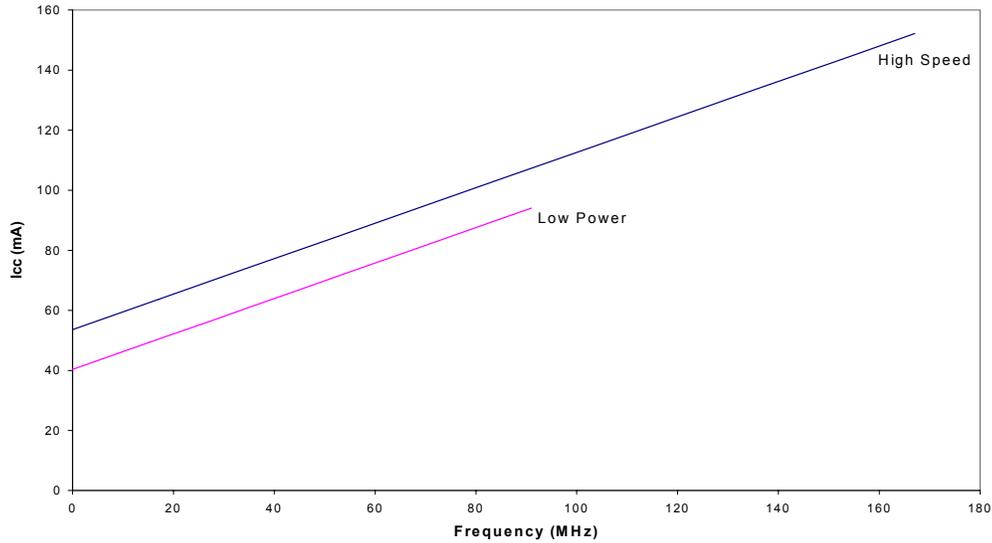
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 5.0V$ ,  $T_A = \text{Room Temperature}$

**CY37064**



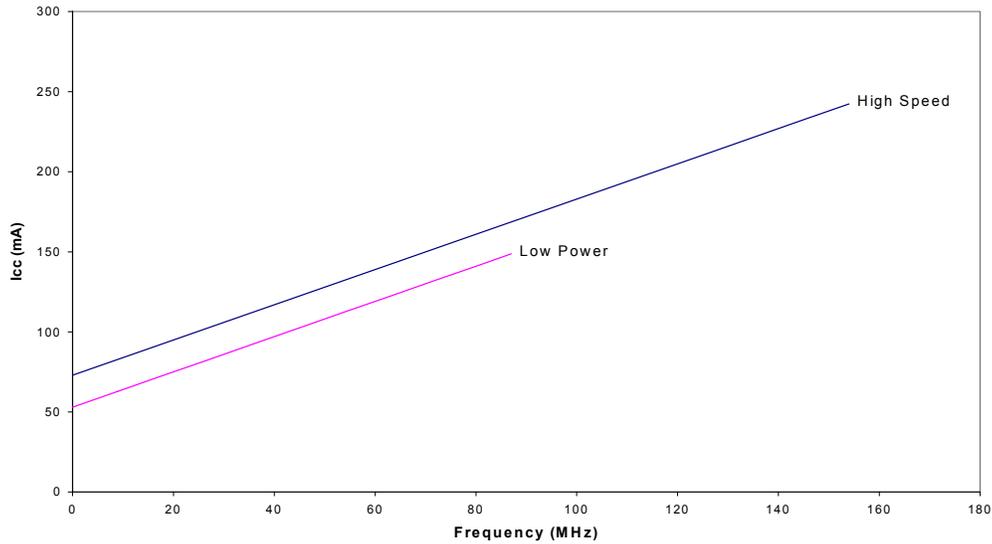
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 5.0V$ ,  $T_A = \text{Room Temperature}$

Typical 5.0V Power Consumption (continued)  
CY37128



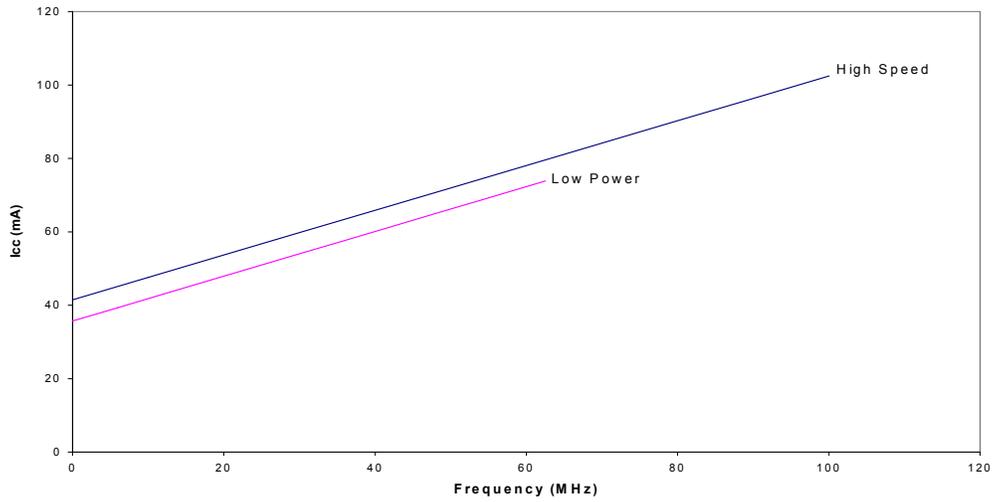
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 5.0V$ ,  $T_A = \text{Room Temperature}$

CY37192



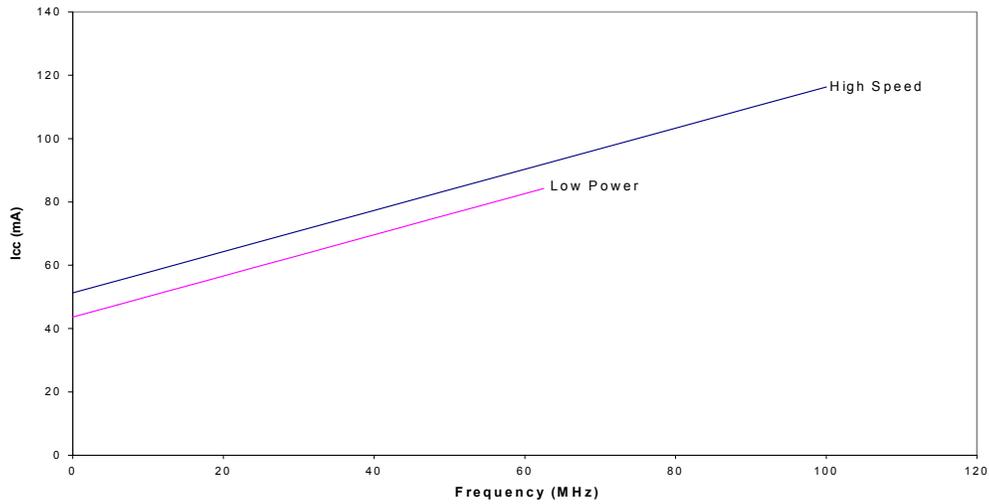
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 5.0V$ ,  $T_A = \text{Room Temperature}$

Typical 3.3V Power Consumption (continued)  
CY37192V



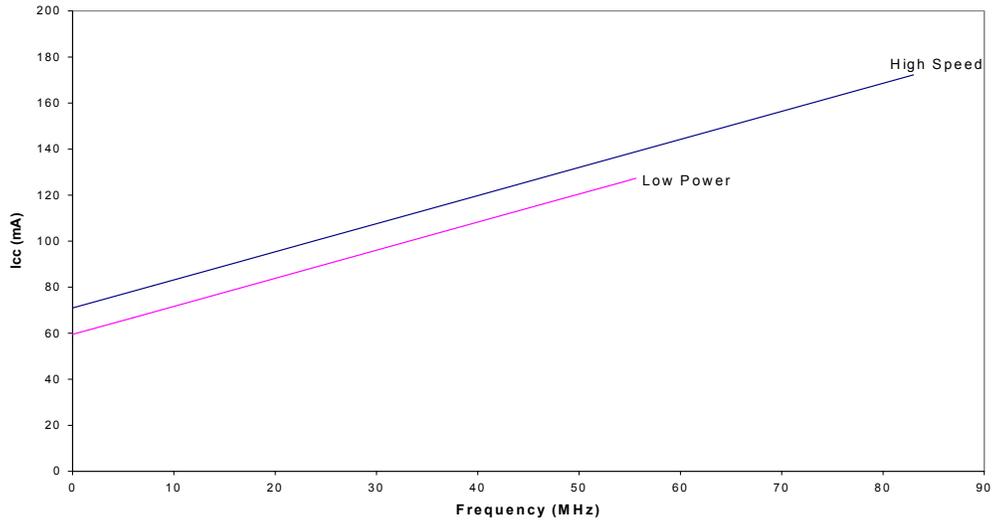
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 3.3V$ ,  $T_A = \text{Room Temperature}$

CY37256V



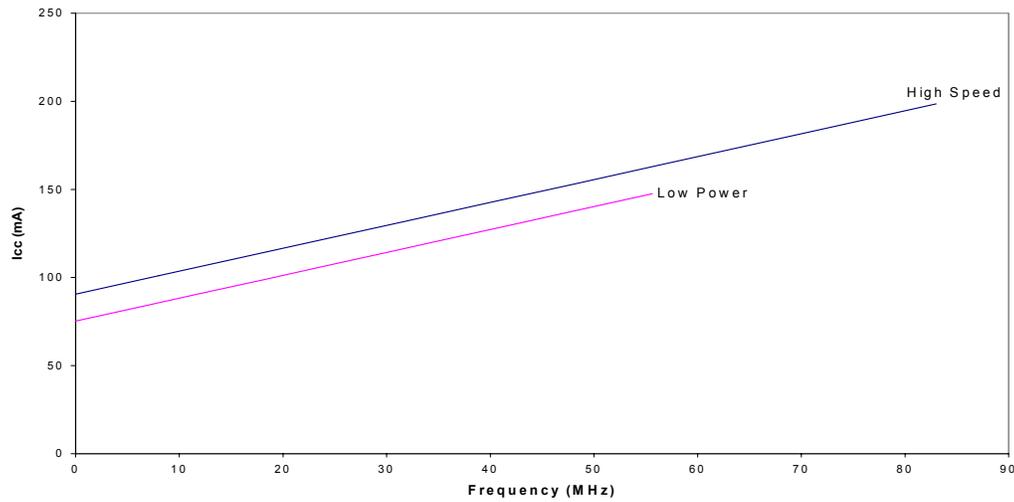
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 3.3V$ ,  $T_A = \text{Room Temperature}$

Typical 3.3V Power Consumption (continued)  
CY37384V



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 3.3V$ ,  $T_A = \text{Room Temperature}$

CY37512V



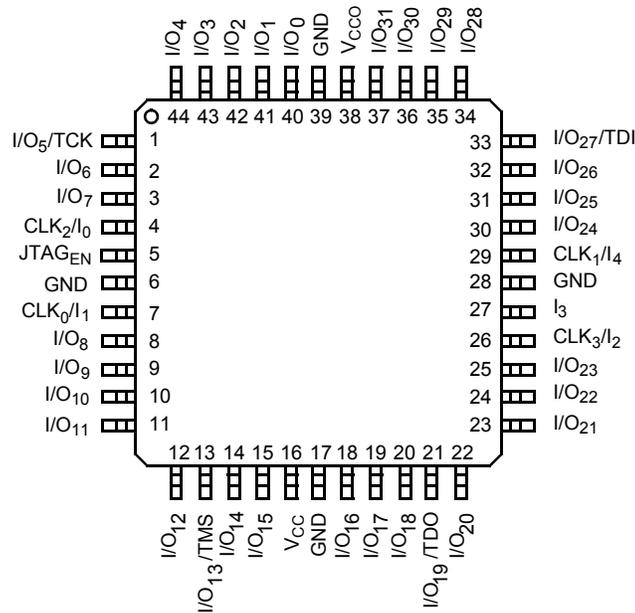
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 3.3V$ ,  $T_A = \text{Room Temperature}$



Pin Configurations<sup>[20]</sup>

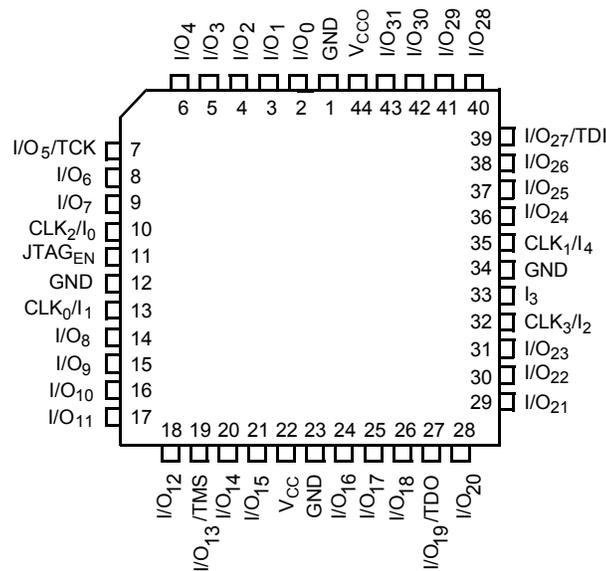
44-pin TQFP (A44)

Top View



44-pin PLCC (J67) / CLCC (Y67)

Top View

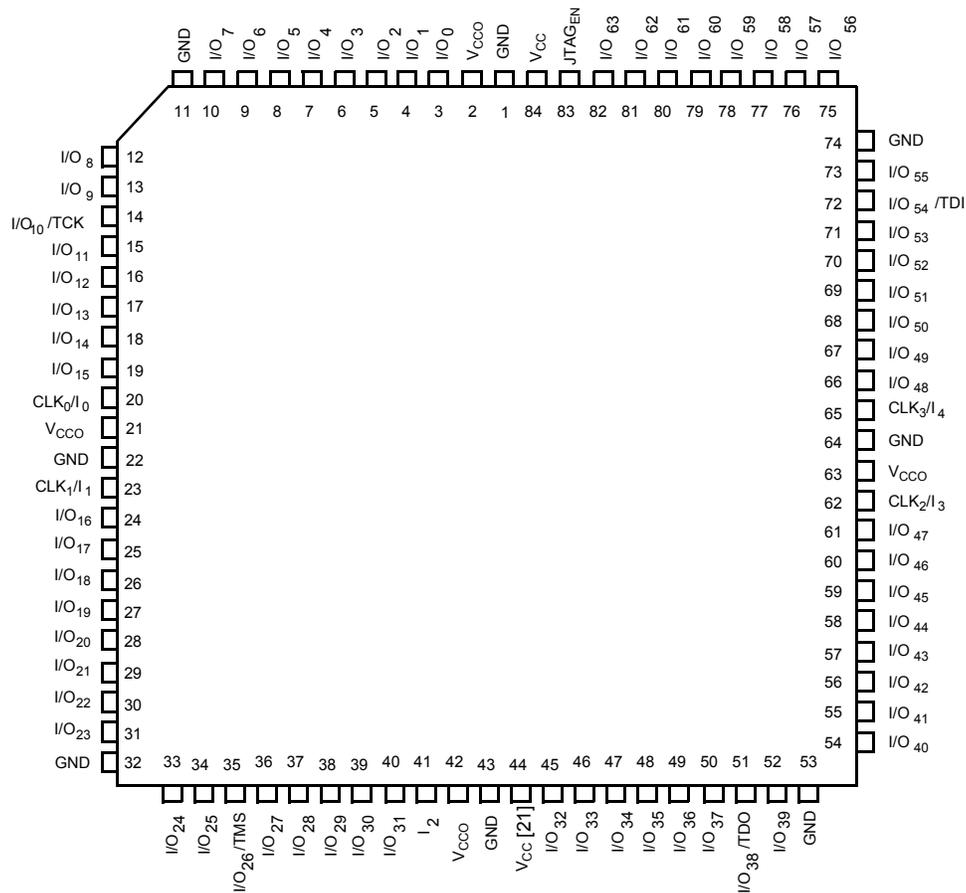



**Pin Configurations<sup>[20]</sup> (continued)**
**48-ball Fine-Pitch BGA (BA50)**
**Top View**

	1	2	3	4	5	6	7	8
A	I/O <sub>5</sub> TCK	V <sub>CC</sub>	I/O <sub>3</sub>	I/O <sub>1</sub>	I/O <sub>31</sub>	I/O <sub>30</sub>	V <sub>CC</sub>	I/O <sub>27</sub> TDI
B	V <sub>CC</sub>	I/O <sub>4</sub>	I/O <sub>2</sub>	I/O <sub>0</sub>	I/O <sub>29</sub>	I/O <sub>28</sub>	I/O <sub>26</sub>	CLK <sub>1</sub> /I <sub>4</sub>
C	CLK <sub>2</sub> /I <sub>0</sub>	I/O <sub>7</sub>	I/O <sub>6</sub>	GND	GND	I/O <sub>25</sub>	I/O <sub>24</sub>	I <sub>3</sub>
D	JTAG <sub>EN</sub>	I/O <sub>8</sub>	I/O <sub>9</sub>	GND	GND	I/O <sub>22</sub>	I/O <sub>23</sub>	CLK <sub>3</sub> /I <sub>2</sub>
E	CLK <sub>0</sub> /I <sub>1</sub>	I/O <sub>12</sub>	I/O <sub>11</sub>	I/O <sub>10</sub>	I/O <sub>16</sub>	I/O <sub>20</sub>	I/O <sub>21</sub>	V <sub>CC</sub>
F	I/O <sub>13</sub> TMS	V <sub>CC</sub>	I/O <sub>14</sub>	I/O <sub>15</sub>	I/O <sub>17</sub>	I/O <sub>18</sub>	V <sub>CC</sub>	I/O <sub>19</sub> TDO

**Note:**

 20. For 3.3V versions (Ultra37000V), V<sub>CC0</sub> = V<sub>CC</sub>.

**84-lead PLCC (J83) / CLCC (Y84)**
**Top View**

**Note:**

 21. This pin is a N/C, but Cypress recommends that you connect it to V<sub>CC</sub> to ensure future compatibility.


**Pin Configurations<sup>[20]</sup> (continued)**
**100-ball Fine-Pitch BGA (BB100) for CY37064V**
**Top View**

	1	2	3	4	5	6	7	8	9	10
A	NC	NC	I/O <sub>7</sub>	I/O <sub>5</sub>	I/O <sub>2</sub>	I/O <sub>62</sub>	I/O <sub>60</sub>	I/O <sub>58</sub>	I/O <sub>57</sub>	I/O <sub>56</sub>
B	I/O <sub>9</sub>	I/O <sub>8</sub>	I/O <sub>6</sub>	I/O <sub>4</sub>	I/O <sub>1</sub>	I/O <sub>63</sub>	V <sub>CC</sub>	I/O <sub>59</sub>	I/O <sub>55</sub>	NC
C	I/O <sub>10</sub>	TCK	V <sub>CC</sub>	I/O <sub>3</sub>	NC	NC	I/O <sub>61</sub>	V <sub>CC</sub>	TDI	I/O <sub>54</sub>
D	I/O <sub>11</sub>	NC	I/O <sub>12</sub>	I/O <sub>13</sub>	I/O <sub>0</sub>	NC	I/O <sub>51</sub>	I/O <sub>52</sub>	CLK <sub>3</sub> / I <sub>4</sub>	I/O <sub>53</sub>
E	I/O <sub>14</sub>	CLK <sub>0</sub> / I <sub>0</sub>	I/O <sub>15</sub>	NC	GND	GND	I/O <sub>48</sub>	I/O <sub>49</sub>	CLK <sub>2</sub> / I <sub>3</sub>	I/O <sub>50</sub>
F	I/O <sub>17</sub>	NC	NC	I/O <sub>16</sub>	GND	GND	NC	NC	I <sub>2</sub>	I/O <sub>47</sub>
G	I/O <sub>22</sub>	CLK <sub>1</sub> / I <sub>1</sub>	I/O <sub>21</sub>	I/O <sub>19</sub>	I/O <sub>18</sub>	I/O <sub>46</sub>	I/O <sub>45</sub>	I/O <sub>44</sub>	NC	I/O <sub>43</sub>
H	I/O <sub>23</sub>	TMS	V <sub>CC</sub>	I/O <sub>20</sub>	NC	I/O <sub>32</sub>	I/O <sub>42</sub>	V <sub>CC</sub>	TDO	I/O <sub>41</sub>
J	NC	I/O <sub>26</sub>	I/O <sub>28</sub>	NC	I/O <sub>31</sub>	I/O <sub>33</sub>	I/O <sub>35</sub>	I/O <sub>37</sub>	I/O <sub>39</sub>	I/O <sub>40</sub>
K	I/O <sub>24</sub>	I/O <sub>25</sub>	I/O <sub>27</sub>	I/O <sub>29</sub>	I/O <sub>30</sub>	I/O <sub>34</sub>	I/O <sub>36</sub>	I/O <sub>38</sub>	NC	NC

**100-ball Fine-Pitch BGA (BB100) for CY37128V**
**Top View**

	1	2	3	4	5	6	7	8	9	10
A	NC	I/O <sub>9</sub>	I/O <sub>8</sub>	I/O <sub>6</sub>	I/O <sub>3</sub>	I/O <sub>76</sub>	I/O <sub>74</sub>	I/O <sub>72</sub>	I/O <sub>71</sub>	I/O <sub>70</sub>
B	I/O <sub>11</sub>	I/O <sub>10</sub>	I/O <sub>7</sub>	I/O <sub>5</sub>	I/O <sub>2</sub>	I/O <sub>77</sub>	V <sub>CC</sub>	I/O <sub>73</sub>	I/O <sub>68</sub>	I/O <sub>69</sub>
C	I/O <sub>12</sub>	I/O <sub>13</sub> TCK	V <sub>CC</sub>	I/O <sub>4</sub>	I/O <sub>1</sub>	I/O <sub>78</sub>	I/O <sub>75</sub>	V <sub>CC</sub>	I/O <sub>67</sub> TDI	I/O <sub>66</sub>
D	I/O <sub>14</sub>	NC	I/O <sub>15</sub>	I/O <sub>16</sub>	I/O <sub>0</sub>	I/O <sub>79</sub>	I/O <sub>63</sub>	I/O <sub>64</sub>	CLK <sub>3</sub> / I <sub>4</sub>	I/O <sub>65</sub>
E	I/O <sub>17</sub>	CLK <sub>0</sub> / I <sub>0</sub>	I/O <sub>18</sub>	I/O <sub>19</sub>	GND	GND	I/O <sub>60</sub>	I/O <sub>61</sub>	CLK <sub>2</sub> / I <sub>3</sub>	I/O <sub>62</sub>
F	I/O <sub>22</sub>	JTAG EN	I/O <sub>21</sub>	I/O <sub>20</sub>	GND	GND	I/O <sub>59</sub>	I/O <sub>58</sub>	I <sub>2</sub>	I/O <sub>57</sub>
G	I/O <sub>27</sub>	CLK <sub>1</sub> / I <sub>1</sub>	I/O <sub>26</sub>	I/O <sub>24</sub>	I/O <sub>23</sub>	I/O <sub>56</sub>	I/O <sub>55</sub>	I/O <sub>54</sub>	NC	I/O <sub>53</sub>
H	I/O <sub>28</sub>	I/O <sub>33</sub> TMS	V <sub>CC</sub>	I/O <sub>25</sub>	I/O <sub>39</sub>	I/O <sub>40</sub>	I/O <sub>52</sub>	V <sub>CC</sub>	I/O <sub>47</sub> TDO	I/O <sub>51</sub>
J	I/O <sub>29</sub>	I/O <sub>32</sub>	I/O <sub>35</sub>	V <sub>CC</sub>	I/O <sub>38</sub>	I/O <sub>41</sub>	I/O <sub>43</sub>	I/O <sub>45</sub>	I/O <sub>48</sub>	I/O <sub>50</sub>
K	I/O <sub>30</sub>	I/O <sub>31</sub>	I/O <sub>34</sub>	I/O <sub>36</sub>	I/O <sub>37</sub>	I/O <sub>42</sub>	I/O <sub>44</sub>	I/O <sub>46</sub>	I/O <sub>49</sub>	NC


**Pin Configurations<sup>[20]</sup> (continued)**
**256-Ball Fine-Pitch BGA (BB256)  
Top View**

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
A	GND	GND	I/O <sub>26</sub>	I/O <sub>24</sub>	I/O <sub>20</sub>	V <sub>CC</sub>	I/O <sub>11</sub>	GND	GND	I/O <sub>186</sub>	V <sub>CC</sub>	I/O <sub>177</sub>	I/O <sub>172</sub>	I/O <sub>167</sub>	GND	GND
B	GND	I/O <sub>27</sub>	I/O <sub>25</sub>	I/O <sub>23</sub>	I/O <sub>19</sub>	I/O <sub>15</sub>	I/O <sub>10</sub>	GND	GND	I/O <sub>185</sub>	I/O <sub>181</sub>	I/O <sub>176</sub>	I/O <sub>171</sub>	I/O <sub>166</sub>	I/O <sub>165</sub>	GND
C	I/O <sub>29</sub>	I/O <sub>28</sub>	NC	I/O <sub>22</sub>	I/O <sub>18</sub>	I/O <sub>14</sub>	I/O <sub>9</sub>	I/O <sub>4</sub>	I/O <sub>191</sub>	I/O <sub>184</sub>	I/O <sub>180</sub>	I/O <sub>175</sub>	I/O <sub>170</sub>	NC	I/O <sub>163</sub>	I/O <sub>164</sub>
D	I/O <sub>32</sub>	I/O <sub>31</sub>	I/O <sub>30</sub>	NC	I/O <sub>17</sub>	I/O <sub>13</sub>	I/O <sub>8</sub>	I/O <sub>3</sub>	I/O <sub>190</sub>	I/O <sub>183</sub>	I/O <sub>179</sub>	I/O <sub>174</sub>	I/O <sub>169</sub>	I/O <sub>160</sub>	I/O <sub>161</sub>	I/O <sub>162</sub>
E	I/O <sub>35</sub>	I/O <sub>34</sub>	I/O <sub>33</sub>	I/O <sub>21</sub>	I/O <sub>16</sub>	I/O <sub>12</sub>	I/O <sub>7</sub>	I/O <sub>2</sub>	I/O <sub>189</sub>	V <sub>CC</sub>	I/O <sub>178</sub>	I/O <sub>173</sub>	I/O <sub>168</sub>	I/O <sub>157</sub>	I/O <sub>158</sub>	I/O <sub>159</sub>
F	V <sub>CC</sub>	I/O <sub>38</sub>	I/O <sub>37</sub>	I/O <sub>36</sub>	TCK	V <sub>CC</sub>	I/O <sub>6</sub>	I/O <sub>1</sub>	I/O <sub>188</sub>	I/O <sub>182</sub>	V <sub>CC</sub>	TDI	I/O <sub>154</sub>	I/O <sub>155</sub>	I/O <sub>156</sub>	V <sub>CC</sub>
G	I/O <sub>43</sub>	I/O <sub>42</sub>	I/O <sub>41</sub>	I/O <sub>40</sub>	V <sub>CC</sub>	I/O <sub>39</sub>	I/O <sub>5</sub>	I/O <sub>0</sub>	I/O <sub>187</sub>	I/O <sub>148</sub>	I/O <sub>149</sub>	CLK <sub>3</sub> I/O <sub>4</sub>	I/O <sub>150</sub>	I/O <sub>151</sub>	I/O <sub>152</sub>	I/O <sub>153</sub>
H	GND	GND	I/O <sub>47</sub>	I/O <sub>46</sub>	CLK <sub>0</sub> I/O <sub>0</sub>	I/O <sub>45</sub>	I/O <sub>44</sub>	GND	GND	I/O <sub>144</sub>	I/O <sub>145</sub>	CLK <sub>2</sub> I/O <sub>3</sub>	I/O <sub>146</sub>	I/O <sub>147</sub>	GND	GND
J	GND	GND	I/O <sub>51</sub>	I/O <sub>50</sub>	NC	I/O <sub>49</sub>	I/O <sub>48</sub>	GND	GND	I/O <sub>140</sub>	I/O <sub>141</sub>	I <sub>2</sub>	I/O <sub>142</sub>	I/O <sub>143</sub>	GND	GND
K	I/O <sub>57</sub>	I/O <sub>56</sub>	I/O <sub>55</sub>	I/O <sub>54</sub>	CLK <sub>1</sub> I/O <sub>1</sub>	I/O <sub>53</sub>	I/O <sub>52</sub>	I/O <sub>91</sub>	I/O <sub>96</sub>	I/O <sub>101</sub>	I/O <sub>135</sub>	V <sub>CC</sub>	I/O <sub>136</sub>	I/O <sub>137</sub>	I/O <sub>138</sub>	I/O <sub>139</sub>
L	V <sub>CC</sub>	I/O <sub>60</sub>	I/O <sub>59</sub>	I/O <sub>58</sub>	TMS	V <sub>CC</sub>	I/O <sub>86</sub>	I/O <sub>92</sub>	I/O <sub>97</sub>	I/O <sub>102</sub>	V <sub>CC</sub>	TDO	I/O <sub>132</sub>	I/O <sub>133</sub>	I/O <sub>134</sub>	V <sub>CC</sub>
M	I/O <sub>63</sub>	I/O <sub>62</sub>	I/O <sub>61</sub>	I/O <sub>72</sub>	I/O <sub>77</sub>	I/O <sub>82</sub>	V <sub>CC</sub>	I/O <sub>93</sub>	I/O <sub>98</sub>	I/O <sub>103</sub>	I/O <sub>108</sub>	I/O <sub>112</sub>	I/O <sub>117</sub>	I/O <sub>129</sub>	I/O <sub>130</sub>	I/O <sub>131</sub>
N	I/O <sub>66</sub>	I/O <sub>65</sub>	I/O <sub>64</sub>	I/O <sub>73</sub>	I/O <sub>78</sub>	I/O <sub>83</sub>	I/O <sub>87</sub>	I/O <sub>94</sub>	I/O <sub>99</sub>	I/O <sub>104</sub>	I/O <sub>109</sub>	I/O <sub>113</sub>	NC	I/O <sub>126</sub>	I/O <sub>127</sub>	I/O <sub>128</sub>
P	I/O <sub>68</sub>	I/O <sub>67</sub>	NC	I/O <sub>74</sub>	I/O <sub>79</sub>	I/O <sub>84</sub>	I/O <sub>88</sub>	I/O <sub>95</sub>	I/O <sub>100</sub>	I/O <sub>105</sub>	I/O <sub>110</sub>	I/O <sub>114</sub>	I/O <sub>118</sub>	NC	I/O <sub>124</sub>	I/O <sub>125</sub>
R	GND	I/O <sub>69</sub>	I/O <sub>70</sub>	I/O <sub>75</sub>	I/O <sub>80</sub>	I/O <sub>85</sub>	I/O <sub>89</sub>	GND	GND	I/O <sub>106</sub>	I/O <sub>111</sub>	I/O <sub>115</sub>	I/O <sub>119</sub>	I/O <sub>121</sub>	I/O <sub>123</sub>	GND
T	GND	GND	I/O <sub>71</sub>	I/O <sub>76</sub>	I/O <sub>81</sub>	V <sub>CC</sub>	I/O <sub>90</sub>	GND	GND	I/O <sub>107</sub>	V <sub>CC</sub>	I/O <sub>116</sub>	I/O <sub>120</sub>	I/O <sub>122</sub>	GND	GND


**5.0V Ordering Information** (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range	
64	154	CY37064P44-154AC	A44	44-Lead Thin Quad Flat Pack	Commercial	
		CY37064P44-154JC	J67	44-Lead Plastic Leaded Chip Carrier		
		CY37064P84-154JC	J83	84-Lead Plastic Leaded Chip Carrier		
		CY37064P100-154AC	A100	100-Lead Thin Quad Flat Pack		
		CY37064P44-154AI	A44	44-Lead Thin Quad Flat Pack	Industrial	
		CY37064P44-154AXI	A44	44-Lead Lead Free Thin Quad Flat Pack		
		CY37064P44-154JI	J67	44-Lead Plastic Leaded Chip Carrier		
		CY37064P44-154JXI	J67	44-Lead Lead Free Plastic Leaded Chip Carrier		
		CY37064P84-154JI	J83	84-Lead Plastic Leaded Chip Carrier		
		CY37064P100-154AI	A100	100-Lead Thin Quad Flat Pack		
	5962-9951902QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	Military		
	125	125	CY37064P44-125AC	A44	44-Lead Thin Quad Flat Pack	Commercial
			CY37064P44-125AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
			CY37064P44-125JC	J67	44-Lead Plastic Leaded Chip Carrier	
			CY37064P44-125JXC	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
			CY37064P84-125JC	J83	84-Lead Plastic Leaded Chip Carrier	
			CY37064P100-125AC	A100	100-Lead Thin Quad Flat Pack	
			CY37064P100-125AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
			CY37064P44-125AI	A44	44-Lead Thin Quad Flat Pack	Industrial
			CY37064P44-125AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
			CY37064P44-125JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P84-125JI	J83	84-Lead Plastic Leaded Chip Carrier		
		CY37064P100-125AI	A100	100-Lead Thin Quad Flat Pack		
CY37064P100-125AXI		A100	100-Lead Lead Free Thin Quad Flat Pack			
5962-9951901QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	Military			


**5.0V Ordering Information** (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range	
512	125	CY37512P208-125NC	N208	208-Lead Plastic Quad Flat Pack	Commercial	
		CY37512P256-125BGC	BG292	292-Ball Plastic Ball Grid Array		
		CY37512P352-125BGC	BG388	388-Ball Plastic Ball Grid Array		
	100	100	CY37512P208-100NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
			CY37512P256-100BGC	BG292	292-Ball Plastic Ball Grid Array	
			CY37512P352-100BGC	BG388	388-Ball Plastic Ball Grid Array	
		Industrial	100	CY37512P208-100NI	N208	208-Lead Plastic Quad Flat Pack
				CY37512P256-100BGI	BG292	292-Ball Plastic Ball Grid Array
				CY37512P352-100BGI	BG388	388-Ball Plastic Ball Grid Array
				5962-9952502QZC	U208	208-Lead Ceramic Quad Flat Pack
	83	100	CY37512P208-83NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
			CY37512P256-83BGC	BG292	292-Ball Plastic Ball Grid Array	
			CY37512P352-83BGC	BG388	388-Ball Plastic Ball Grid Array	
		Industrial	83	CY37512P208-83NI	N208	208-Lead Plastic Quad Flat Pack
				CY37512P256-83BGI	BG292	292-Ball Plastic Ball Grid Array
CY37512P352-83BGI				BG388	388-Ball Plastic Ball Grid Array	
5962-9952501QZC				U208	208-Lead Ceramic Quad Flat Pack	Military

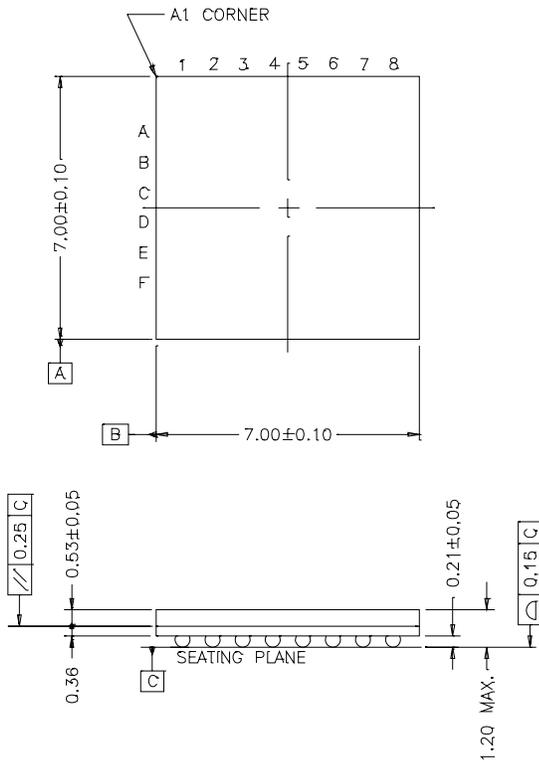
**3.3V Ordering Information**

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range	
32	143	CY37032VP44-143AC	A44	44-Lead Thin Quad Flat Pack	Commercial	
		CY37032VP44-143AXC	A44	44-Lead Lead Free Thin Quad Flat Pack		
		CY37032VP48-143BAC	BA50	48-Ball Fine Pitch Ball Grid Array		
	100	100	CY37032VP44-100AC	A44	44-Lead Thin Quad Flat Pack	Commercial
			CY37032VP44-100AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
			CY37032VP48-100BAC	BA50	48-Ball Fine Pitch Ball Grid Array	
		Industrial	100	CY37032VP44-100AI	A44	44-Lead Thin Quad Flat Pack
				CY37032VP44-100AXI	A44	44-Lead Lead Free Thin Quad Flat Pack
				CY37032VP48-100BAI	BA50	48-Ball Fine Pitch Ball Grid Array
				CY37032VP44-100JI	J67	44-Lead Plastic Leaded Chip Carrier
				CY37032VP44-100JXI	J67	44-Lead Lead Free Plastic Leaded Chip Carrier

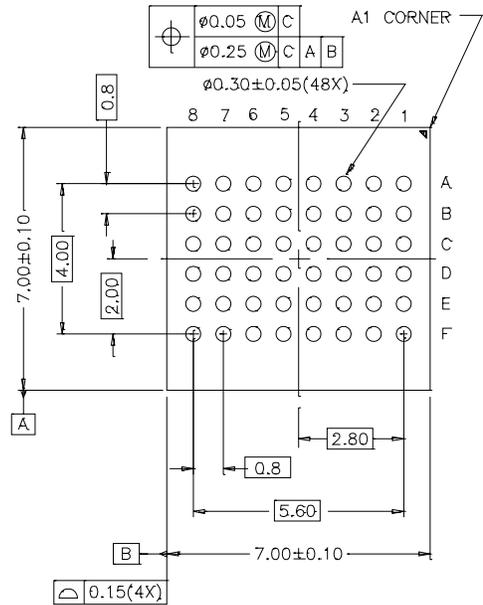
Package Diagrams (continued)

48-Ball (7.0 mm x 7.0 mm x 1.2 mm, 0.80 pitch) Thin BGA BA48D

TOP VIEW



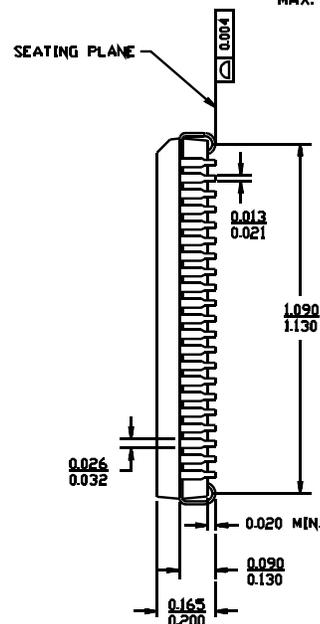
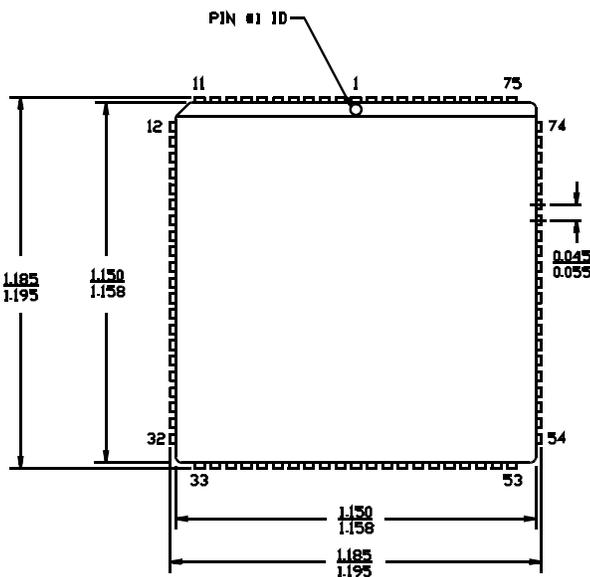
BOTTOM VIEW



51-85109-\*C

84-Lead Lead (Pb)-Free Plastic Leaded Chip Carrier J83

DIMENSIONS IN INCHES MIN. MAX.



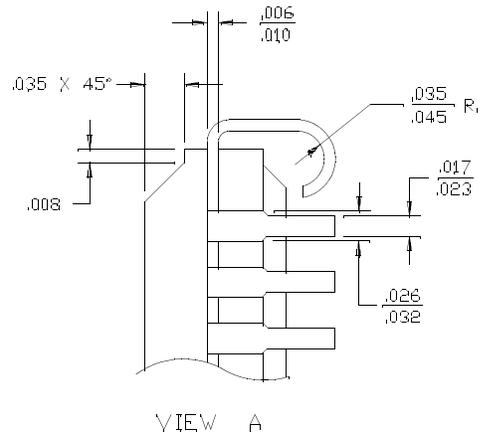
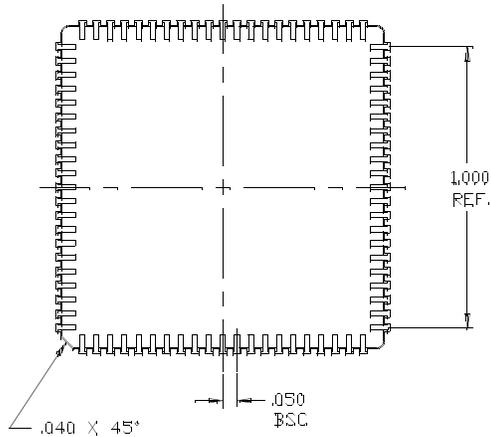
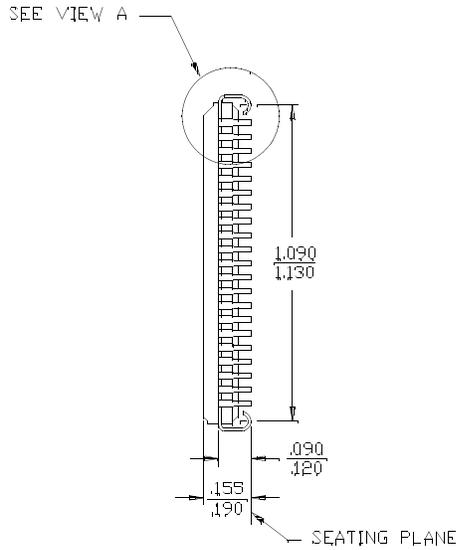
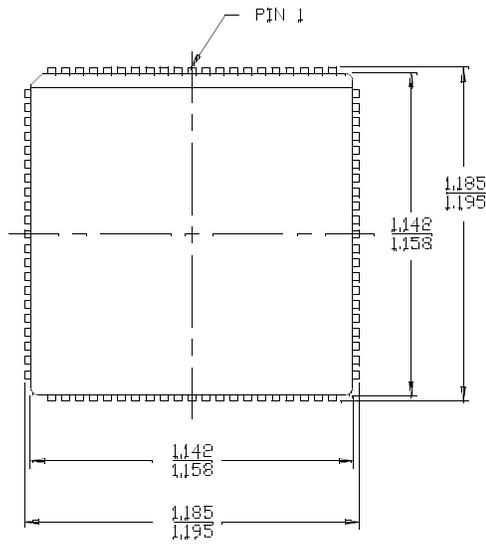
51-85006-\*A

Package Diagrams (continued)

84-Lead Ceramic Leaded Chip Carrier Y84

DIMENSIONS IN INCHES

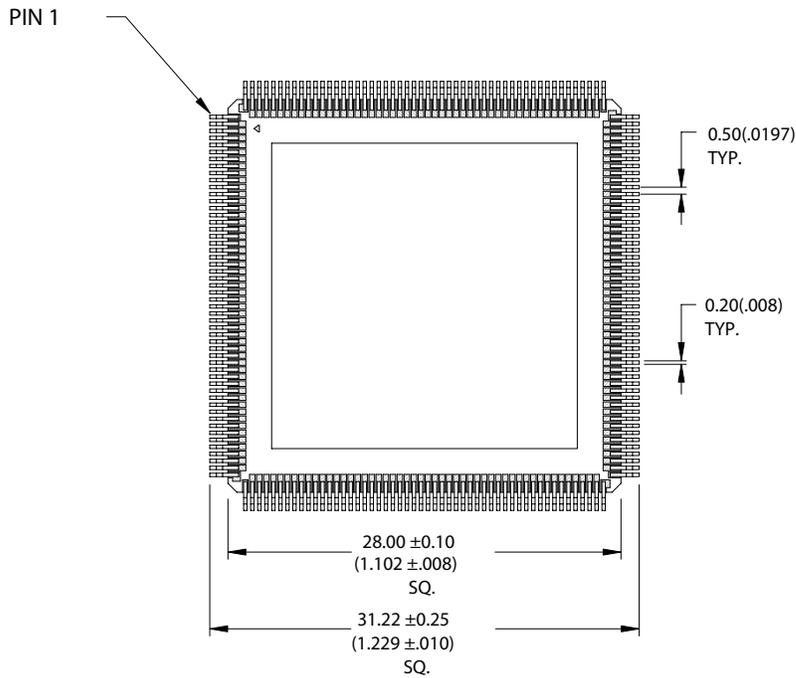
MIN.  
MAX.



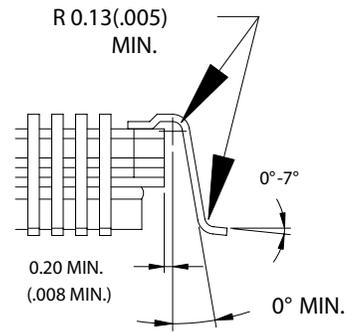
51-80095-\*A

Package Diagrams (continued)

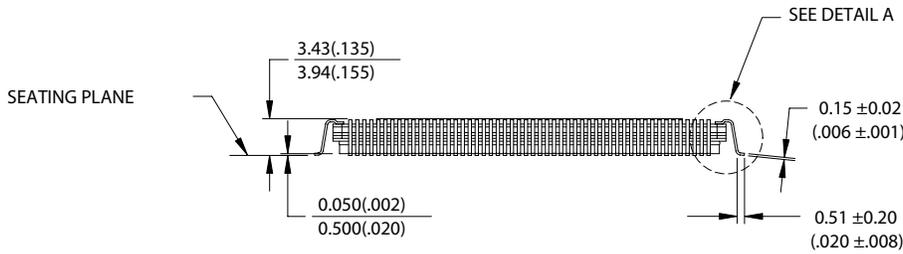
208-Lead Ceramic Quad Flatpack (Cavity Up) U208



DIMENSIONS IN MM (INCH)  
 REFERENCE JEDEC: N/A  
 PKG. WEIGHT: 6-7gms



DETAIL A

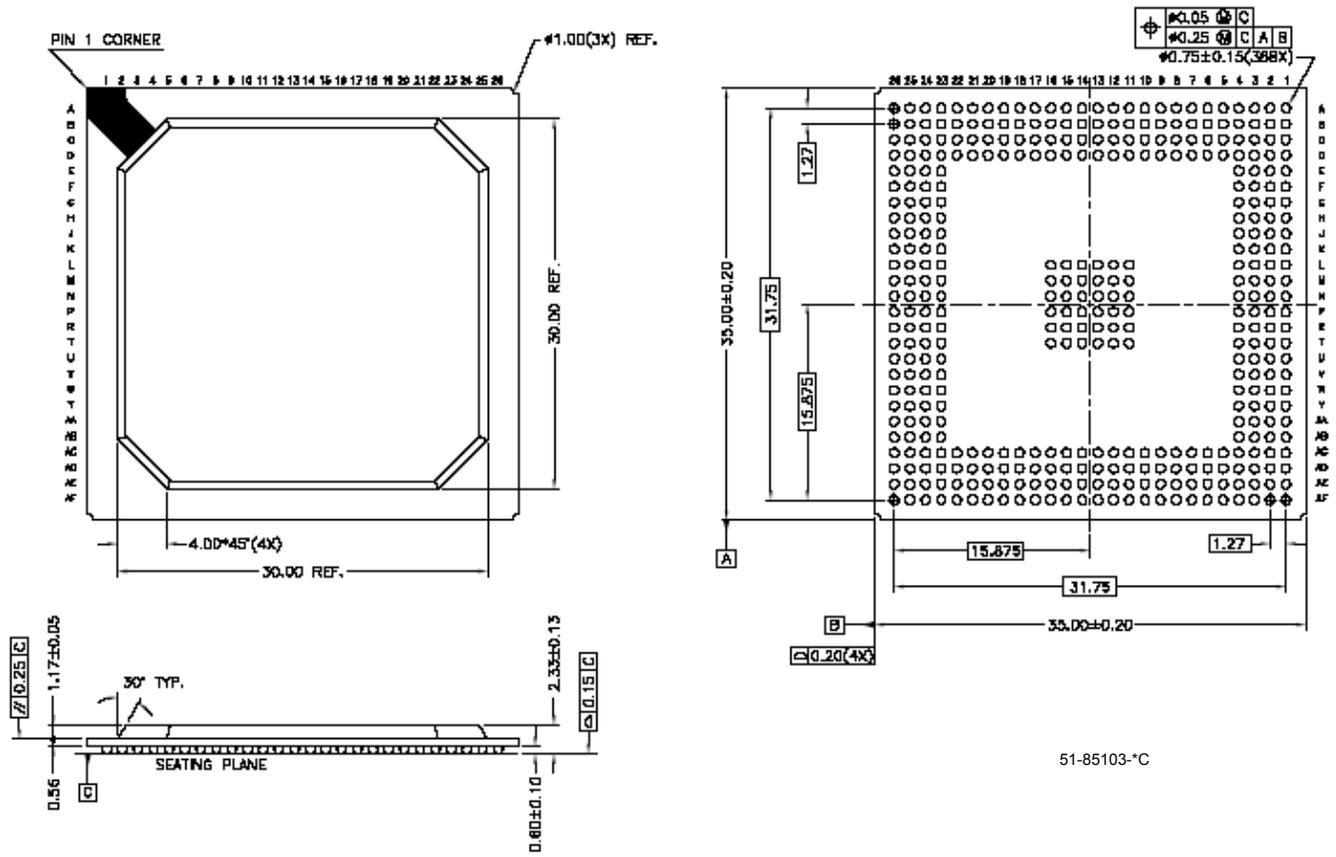


51-80105-\*B



Package Diagrams (continued)

388-Ball Plastic Ball Grid Array PBGA (35 x 35 x 2.33 mm) BG388



51-85103-1C